



June 20, 2010

**Statement Regarding the use of PFOS in Spansion Flash Memory Products**

EU Directive 2006/ 122/ EC restricts PFOS (Perfluorooctanesulfonates) in goods sold in the EU market as of June 27, 2008.

Spansion has evaluated the use of PFOS and PFOA (Perfluorooctanoic acid) and concluded these compounds play important roles in the photo resists and anti-reflective coatings used in the semiconductor industry for manufacture of integrated circuit die. Regulatory exemptions will allow us to continue using these materials in critical applications until technically viable alternatives are available.

Spansion recognizes the potential environmental and human health impacts associated with this category of chemicals, and is actively working with our suppliers to identify PFOS- and PFOA-free alternatives. In the interim, Spansion is actively minimizing the use of these materials in its world wide operations, and is working with trade associations to eliminate or reduce their impact to the environment.

While our IC manufacturing process uses PFOS, neither PFOS nor PFOA are contained in Spansion's final products.

A complete listing of items present in Spansion products is listed in Material Data Declaration Sheets posted online at:  
<http://www.spansion.com/Support/TechnicalDocuments/PackagingHandbook/span-sion-03packagematerials.pdf>

For questions specific to Spansion's voluntary compliance with product restrictions, please contact [product.sustainability@spansion.com](mailto:product.sustainability@spansion.com).

Spansion, Inc.

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